



Product Change Notification

Date: Tuesday, October 5, 2010
PCN#: 140A00191
Subject: W72M64VB-XBX End of Life

Dear Customer,

In an effort to better communicate to you, our user community, we have implemented a e-mail version for our PCN process in addition to our PCN website. While you may receive a notification from us concerning a particular part or part numbers, it is not an indication that you use or have ordered these particular parts, but merely a communication to notify our user community as a whole. Please review your sales orders, POs, records, etc. to determine if this particular PCN impacts your activities or affects your business.

Microsemi Power and Microelectronics Group wishes to inform you of an End of Life for the following part number: W72M64VB-XBX. The die from Spansion will no longer be available and there is no viable replacement die for this part. Microsemi will place a Last Time Buy on the die to cover customer needs. Microsemi requests that customers place LTB orders by December 15th, 2010. If you have any questions, please contact the factory.

As technology moves at a much faster pace, advanced embedded electronic components play a more strategic role. Constant changes and advancements in technology mandate that we anticipate changes and directions in technology for the benefit of our customers. As one of the pioneers in advanced semiconductor packaging and high-density memory solutions, we stand ready to assist you in managing this evolution of technology. If we can provide any additional assistance, please contact us at 602.437.1520 or complete a contact form at www.whiteedc.com/contact_us.html.

Best regards,
Microsemi Power and Microelectronics Group Engineering